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With the principle of "Quality Parts,Customers Priority,Honest Operation, and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

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| Parameter | Rating | Units |
| :--- | :---: | :---: |
| Blocking Voltage | 60 | $\mathrm{~V}_{\mathrm{P}}$ |
| Load Current | 600 | $\mathrm{~mA}_{\text {rms }} / \mathrm{mA}_{\mathrm{DC}}$ |
| On-Resistance (max) | 0.8 | $\Omega$ |
| LED Current to operate | 1 | mA |

## Features

- Designed for Use in Security Systems Complying with EN50130-4
- Only 1 mA of LED Current Required to Operate
- $1500 \mathrm{~V}_{\text {rms }}$ Input/Output Isolation
- Small 4-Pin SOP Package
- High Reliability
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Immune to Radiated EM Fields
- Wave Solderable
- Tape \& Reel Version Available


## Applications

- Security
- Passive Infrared Detectors (PIR)
- Data Signalling
- Sensor Circuitry
- Instrumentation
- Multiplexers
- Data Acquisition
- Electronic Switching
- I/O Subsystems
- Meters (Watt-Hour, Water, Gas)
- Medical Equipment—Patient/Equipment Isolation
- Aerospace
- Industrial Controls


## Description

The CPC1018N is a miniature single-pole, normally-open (1-Form-A) solid state relay in a 4-pin SOP package that employs optically coupled MOSFET technology to provide $1500 \mathrm{~V}_{\text {rms }}$ of input to output isolation. The super efficient MOSFET switches and photovoltaic die use IXYS Integrated Circuits Division's patented OptoMOS architecture while the optically coupled output is controlled by a highly efficient infrared LED.

IXYS Integrated Circuits Division's state of the art double-molded vertical construction packaging enables the CPC1018N to be one of the world's smallest relays. It offers board space savings of at least $20 \%$ over the competitor's larger 4-pin SOP relay.

## Approvals

- UL Recognized Component: File E76270
- CSA Certified Component: Certificate 1172007
- EN/IEC 60950-1 Certified Component: Certificate B 131282667003


## Ordering Information

| Part \# | Description |
| :--- | :--- |
| CPC1018N | 4-Pin SOP (100/tube) |
| CPC1018NTR | 4-Pin SOP (2000/reel) |

## Pin Configuration


of Normally-Open Devices


## Absolute Maximum Ratings @ $25^{\circ} \mathrm{C}$

| Parameter | Ratings | Units |
| :--- | :---: | :---: |
| Blocking Voltage | 60 | $\mathrm{~V}_{\mathrm{p}}$ |
| Reverse Input Voltage | 5 | V |
| Input Control Current <br> Peak (10ms) | 50 | mA |
|  | 1 | A |
| Input Power Dissipation | 70 | mW |
| Total Power Dissipation ${ }^{1}$ | 400 | mW |
| Isolation Voltage, Input to Output | 1500 | $\mathrm{~V}_{\text {rms }}$ |
| Operational Temperature | -40 to +85 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature | -40 to +125 | ${ }^{\circ} \mathrm{C}$ |

${ }^{1}$ Derate linearly $3.33 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Typical values are characteristic of the device at $+25^{\circ} \mathrm{C}$, and are the result of engineering evaluations. They are provided for information purposes only, and are not part of the manufacturing testing requirements.

## Electrical Characteristics @ $25^{\circ} \mathrm{C}$

| Parameter | Conditions | Symbol | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Output Characteristics |  |  |  |  |  |  |
| Load Current Continuous ${ }^{1}$ | $\mathrm{I}_{\mathrm{F}}=2 \mathrm{~mA}$ | $\mathrm{I}_{\mathrm{L}}$ | - | - | 600 | $m A_{\text {rms }} / \mathrm{mA}_{\text {DC }}$ |
| Peak | $t=10 \mathrm{~ms}$ | ILPK | - | - | $\pm 1$ | $\mathrm{A}_{\mathrm{P}}$ |
| On-Resistance ${ }^{2}$ | $\mathrm{I}_{\mathrm{L}}=100 \mathrm{~mA}$ | $\mathrm{R}_{\mathrm{ON}}$ | - | 0.58 | 0.8 | $\Omega$ |
| Off-State Leakage Current | $\mathrm{V}_{\mathrm{L}}=60 \mathrm{~V}_{\mathrm{P}}$ | $\mathrm{I}_{\text {LEAK }}$ | - | - | 1 | $\mu \mathrm{A}$ |
| Switching Speeds Turn-On | $5 \mathrm{~mA}, \mathrm{~V}_{\mathrm{L}}=10 \mathrm{~V}$ | $\mathrm{t}_{\text {on }}$ | - | 0.47 | 3 | ms |
| Turn-Off | A, $\mathrm{L}_{\mathrm{L}}=$ | $\mathrm{t}_{\text {off }}$ | - | 0.22 | 2 |  |
| Output Capacitance | $\mathrm{I}_{\mathrm{F}}=0 \mathrm{~mA}, \mathrm{~V}_{\mathrm{L}}=50 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ | $\mathrm{C}_{\text {OUT }}$ | - | 25 | - | pF |
| Input Characteristics |  |  |  |  |  |  |
| Input Control Current to Activate ${ }^{3}$ | $\mathrm{I}_{\mathrm{L}}=600 \mathrm{~mA}$ | $I_{F}$ | - | 0.2 | 1 | mA |
| Input Control Current to Deactivate | - | $I_{\text {F }}$ | 0.1 | 0.2 | - | mA |
| Input Voltage Drop | $\mathrm{I}_{\mathrm{F}}=5 \mathrm{~mA}$ | $V_{F}$ | 0.9 | 1.2 | 1.4 | V |
| Reverse Input Current | $\mathrm{V}_{\mathrm{R}}=5 \mathrm{~V}$ | $I_{\text {R }}$ | - | - | 10 | $\mu \mathrm{A}$ |
| Common Characteristics |  |  |  |  |  |  |
| Capacitance, Input to Output | $\mathrm{V}_{10}=0 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ | $\mathrm{C}_{10}$ | - | 1 | - | pF |

[^0]PERFORMANCE DATA @ $25^{\circ} \mathrm{C}$ (Unless Otherwise Noted)*

*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

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## Manufacturing Information

Moisture Sensitivity



All plastic encapsulated semiconductor packages are susceptible to moisture ingression. IXYS Integrated Circuits Division classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, IPC/JEDEC J-STD-020, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a Moisture Sensitivity Level (MSL) rating as shown below, and should be handled according to the requirements of the latest version of the joint industry standard IPC/JEDEC J-STD-033.

| Device | Moisture Sensitivity Level (MSL) Rating |
| :---: | :---: |
| CPC1018N | MSL 3 |

## ESD Sensitivity

This product is ESD Sensitive, and should be handled according to the industry standard JESD-625.

## Soldering Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of J-STD-020 must be observed.

| Device | Maximum Temperature x Time | Maximum Reflow Cycles |
| :---: | :---: | :---: |
| CPC1018N | $260^{\circ} \mathrm{C}$ for 30 seconds | 3 |

## Board Wash

IXYS Integrated Circuits Division recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since IXYS Integrated Circuits Division employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.

MECHANICAL DIMENSIONS

## CPC1018N



## CPC1018NTR Tape \& Reel



Embossment
NOTE: All dimensional tolerances per Standard EIA-481-2 except as noted

## For additional information please visit our website at: www.ixysic.com

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[^0]:    1 Load current derates linearly from $600 \mathrm{~mA} @ 25^{\circ} \mathrm{C}$ to $480 \mathrm{~mA} @ 80^{\circ} \mathrm{C}$.
    2 Measurement taken within 1 second of on-time.
    3 For applications requiring high temperature operation (greater than $60^{\circ} \mathrm{C}$ ) a minimum LED drive current of 3 mA is recommended.

